

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Jun-ichiro FURIHATA et al.

Prior Group Art Unit: 2812

Application No.: New Rule 53(b) Divisional of
Application No. 09/787,038

Prior Examiner: C. Lattin

Filed: October 23, 2003

Docket No.: 108868.01

For: METHOD OF PRODUCING A BONDED WAFER AND THE BONDED WAFER

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Prior to initial examination, the following is submitted:

Amendments to the Specification; and

Remarks.